

## Claims

- 5        1. A method of manufacturing a plurality of data carriers from a support strip, a data carrier comprising a data carrier body provided with a microcircuit, the support strip comprising a plurality of support elements (1a, 1b, 1c), a support element comprising wiring pads, the method comprising the following steps:
  - 10           - an overmoulding step, in which the support elements of the support strip are overmoulded so as to obtain a plurality of data carrier bodies ; and
  - a microcircuit-connecting step, in which microcircuits are electrically connected to the wiring pads (3) of the data carrier bodies so as to obtain a plurality of data carriers.
- 15        2. The method according to claim 1, wherein the method further comprises a cutting step, in which the data carriers are cut out.
- 20        3. A support strip comprising roughly parallel gripping areas (10), the support strip comprising in addition a number of support elements (1a, 1b, 1c), a support element comprising conducting elements, a conducting element comprising a contact pad and a wiring pad, the support strip being characterised in that a support element (1a) is connected to a gripping area (10) using a snap-off junction area (11).
- 25        4. The support strip according to claim 3, characterised in that the support element (1a) is a support grid.

5. The support strip according to claim 3, characterised in that the support element (1a) comprises a foolproofing edge (6a).
  6. The support strip according to claim 4, characterised in that the support element (1a) comprises a second foolproofing edge (6b).
  7. The support strip according to claim 3, characterised in that the support element (1a) is metallic.
- 10 8. The support strip according to claim 4, characterised in that the support element (1a) has a contour whose geometry substantially complies with standard GSM 11.11.
- 15 9. The support strip according to claim 3, wherein the support element is arranged to receive an electronic component.